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Murphy et al.

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(54) **HEAT SINK**

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(**) Term: **14 Years**

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(51) **LOC (10) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/179**

(58) **Field of Classification Search**
USPC D13/179

CPC F28D 1/0246; F28D 1/0426; F28D 15/02;
F28D 15/0266; F28D 15/0275; F28D 15/04;
F28F 13/003; F28F 13/12; F28F 1/325;
F04D 25/0613; F04D 25/068; F04D
29/281422; F21V 29/2293; F21V 29/2231;
G03B 21/16; G06F 1/20; G06F 1/203; H01L
23/34; H01L 23/367; H01L 23/3672; H01L
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23/427; H01L 23/467; H05K 7/20; H05K
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H05K 7/20172; H05K 7/20336

See application file for complete search history.

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(74) *Attorney, Agent, or Firm* — GE Global Patent
Operation; John A. Kramer

(57) **CLAIM**

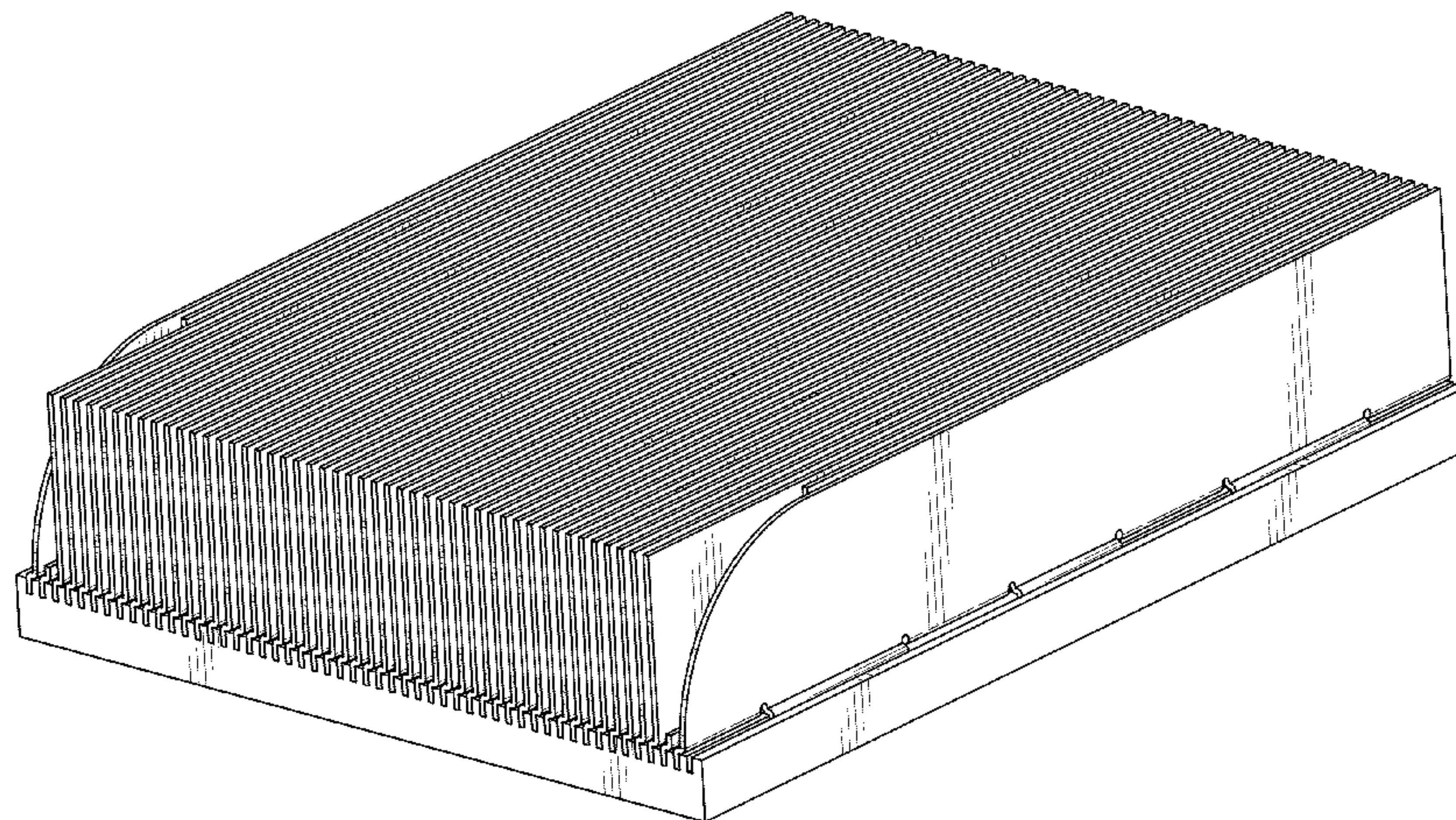
The ornamental design for a heat sink, as shown and
described.

DESCRIPTION

FIG. 1 is a perspective view of a heat sink depicting a first
embodiment of a new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left side elevational view thereof;
FIG. 5 is a right side elevational view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof;
FIG. 8 is a perspective view of a heat sink depicting a second
embodiment of a new design;
FIG. 9 is a front elevational view thereof;
FIG. 10 is a rear elevational view thereof;
FIG. 11 is a left side elevational view thereof;
FIG. 12 is a right side elevational view thereof;
FIG. 13 is a top plan view thereof; and,
FIG. 14 is a bottom plan view thereof.

The broken line portion of the drawings is included to show
unclaimed subject matter only and forms no part of the
claimed design.

1 Claim, 10 Drawing Sheets



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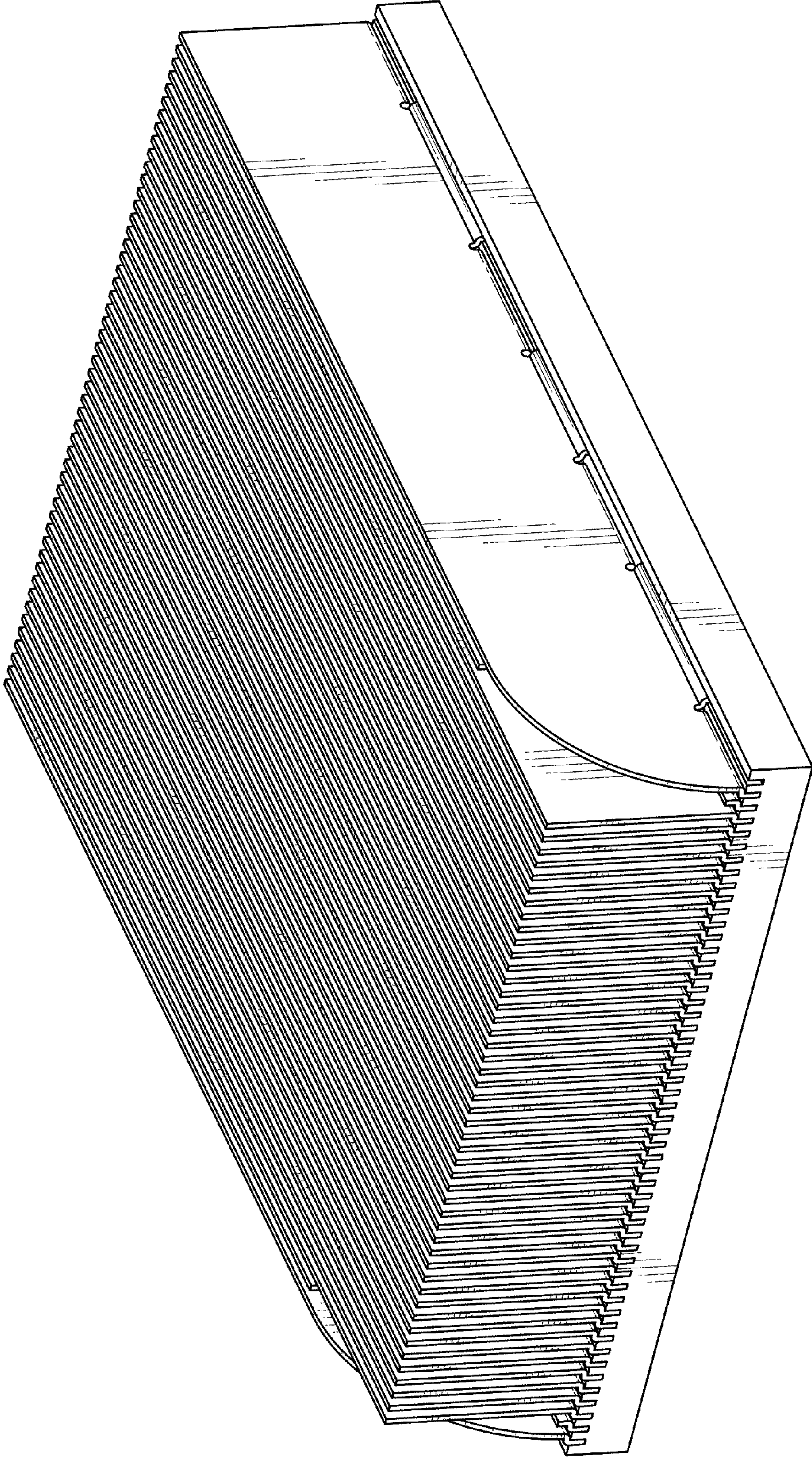


FIG. 1

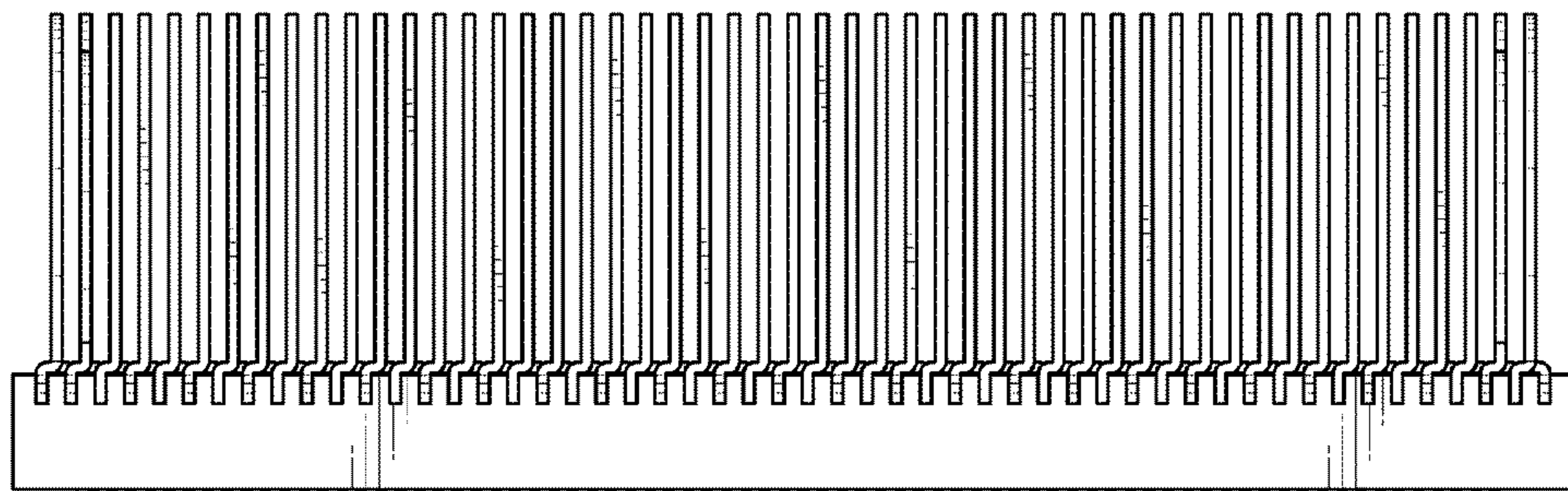


FIG. 2

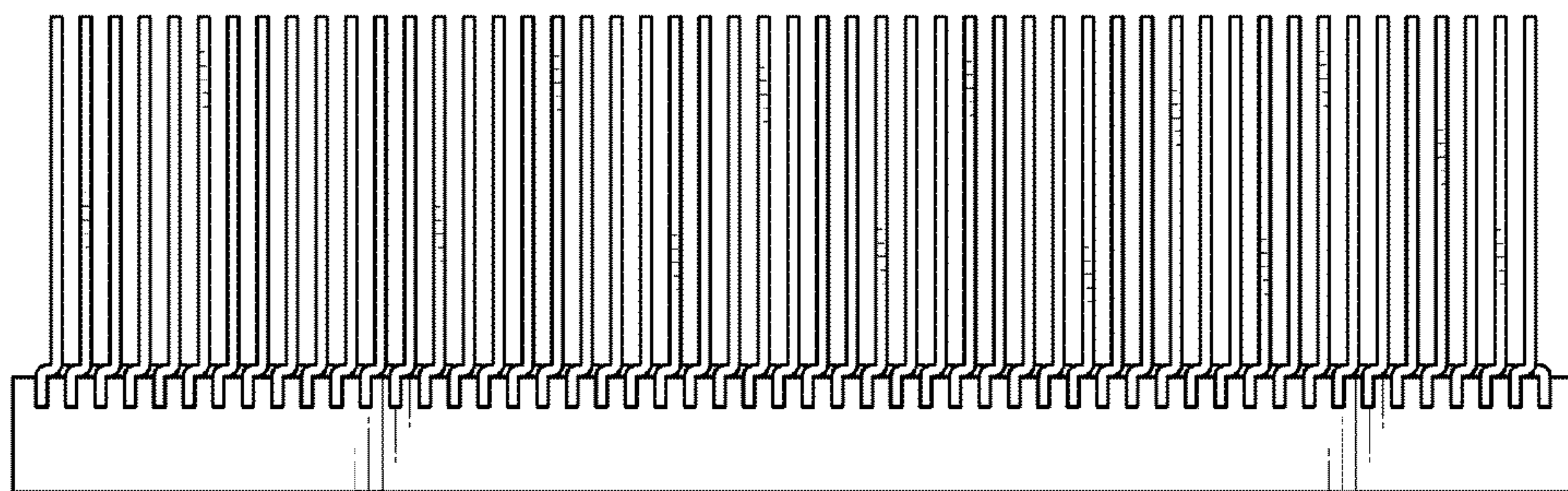


FIG. 3

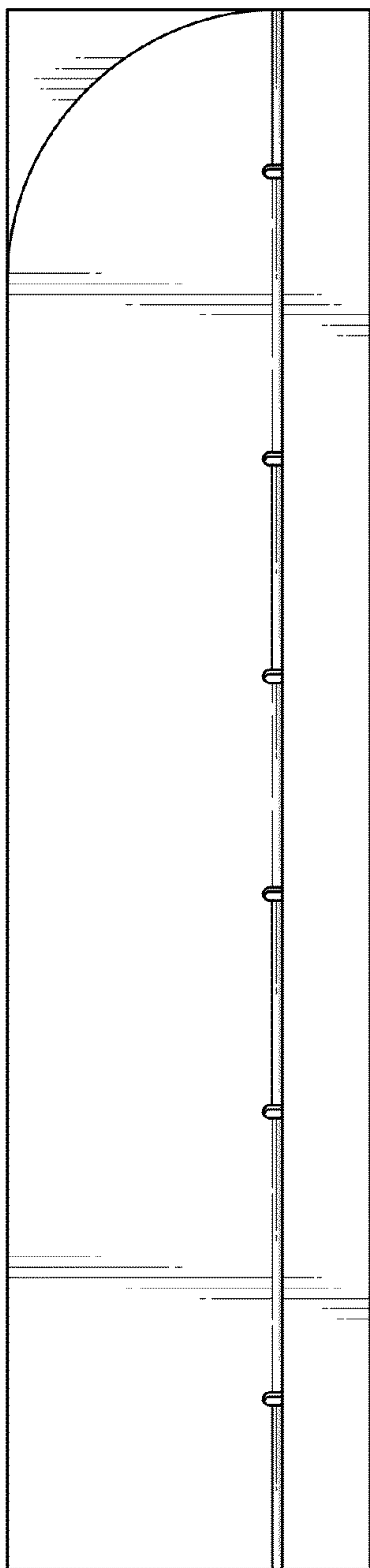


FIG. 4

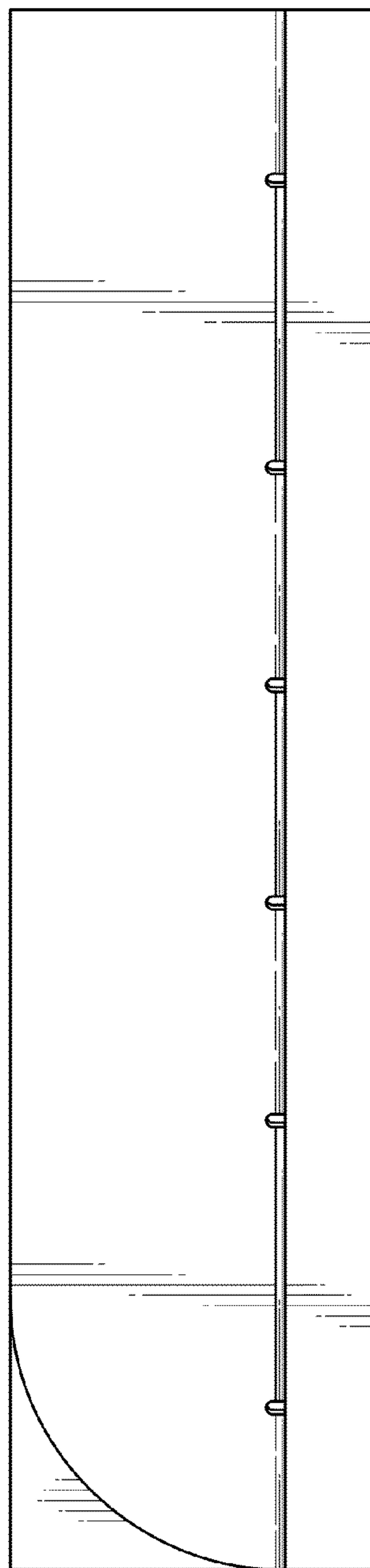


FIG. 5

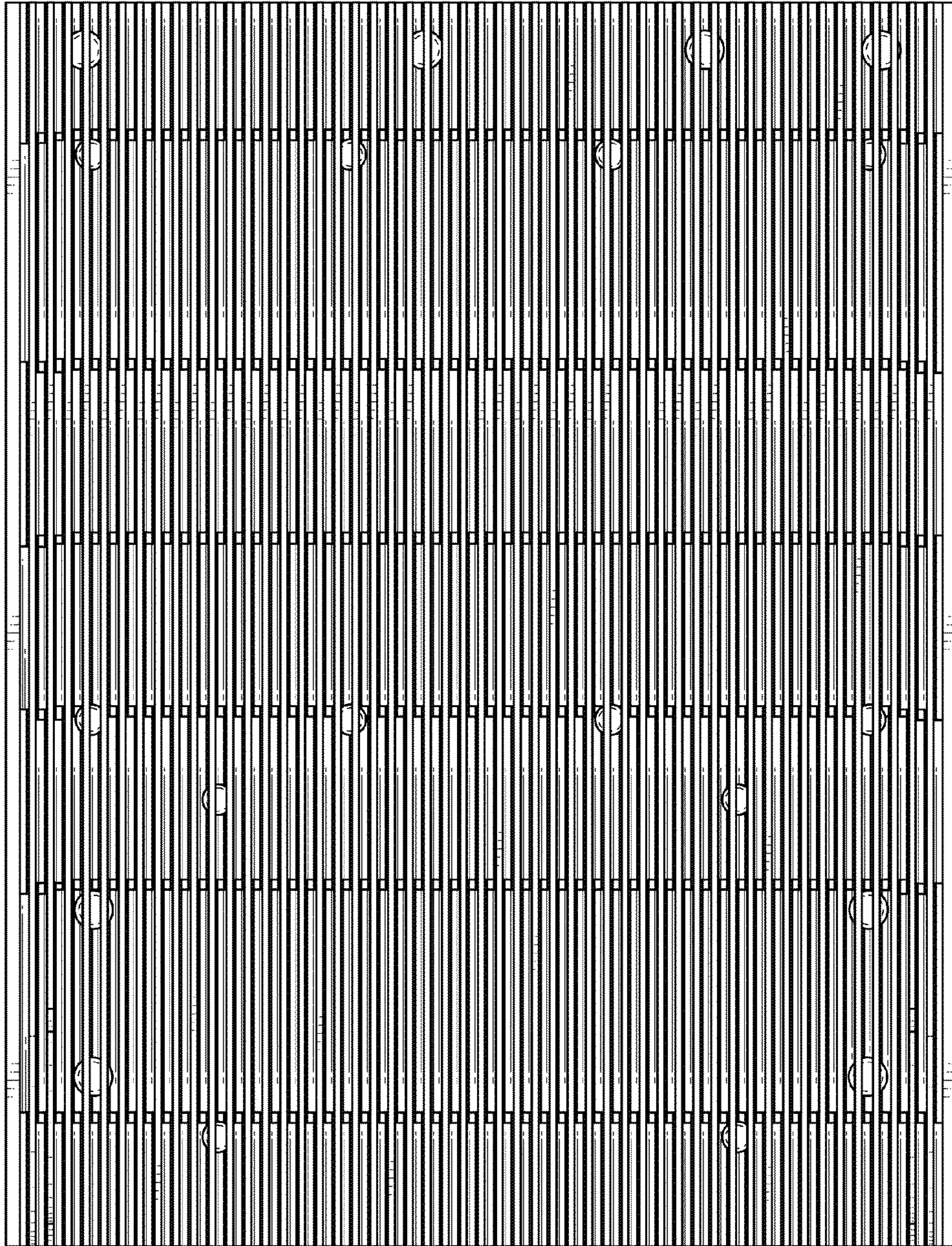


FIG. 6

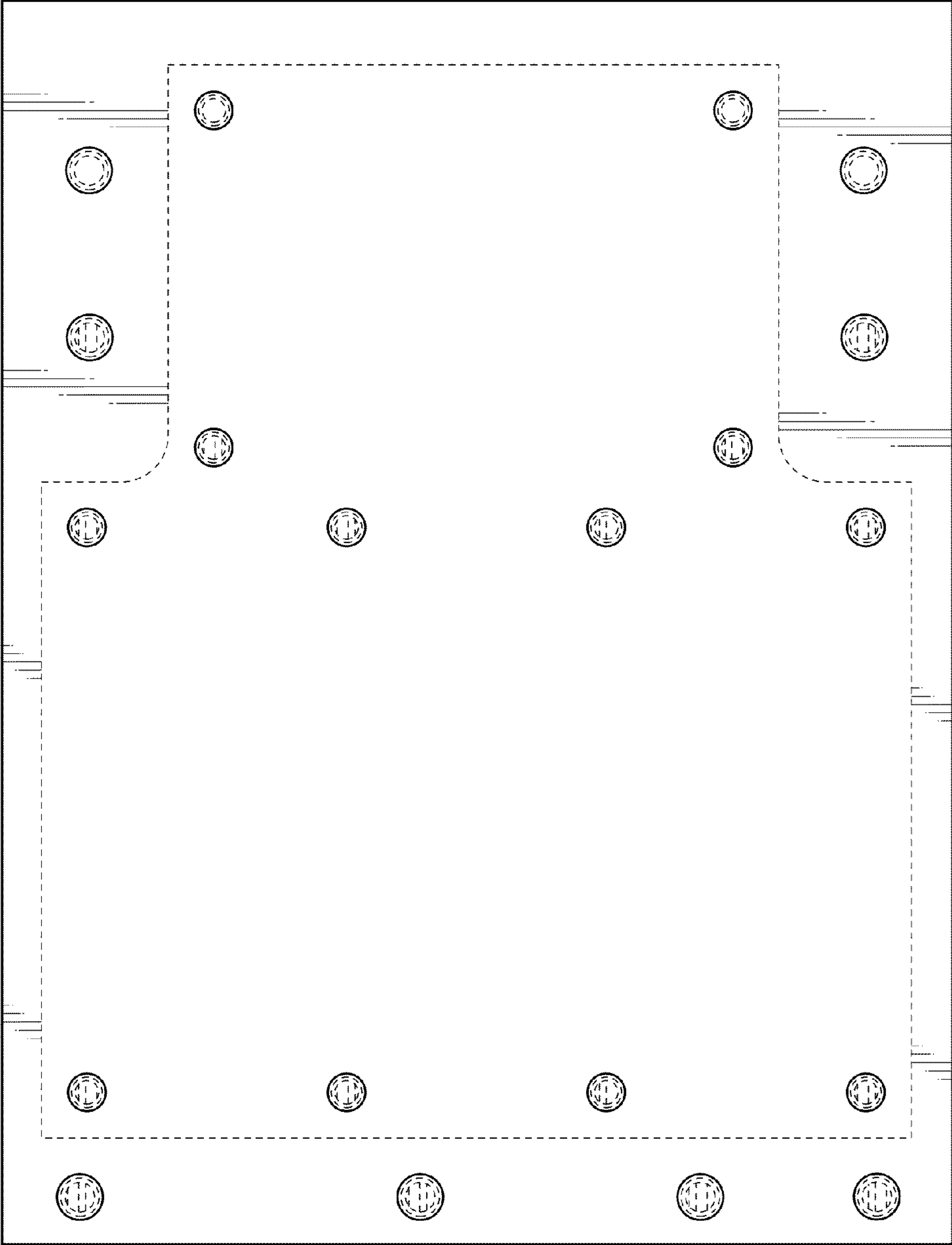


FIG. 7

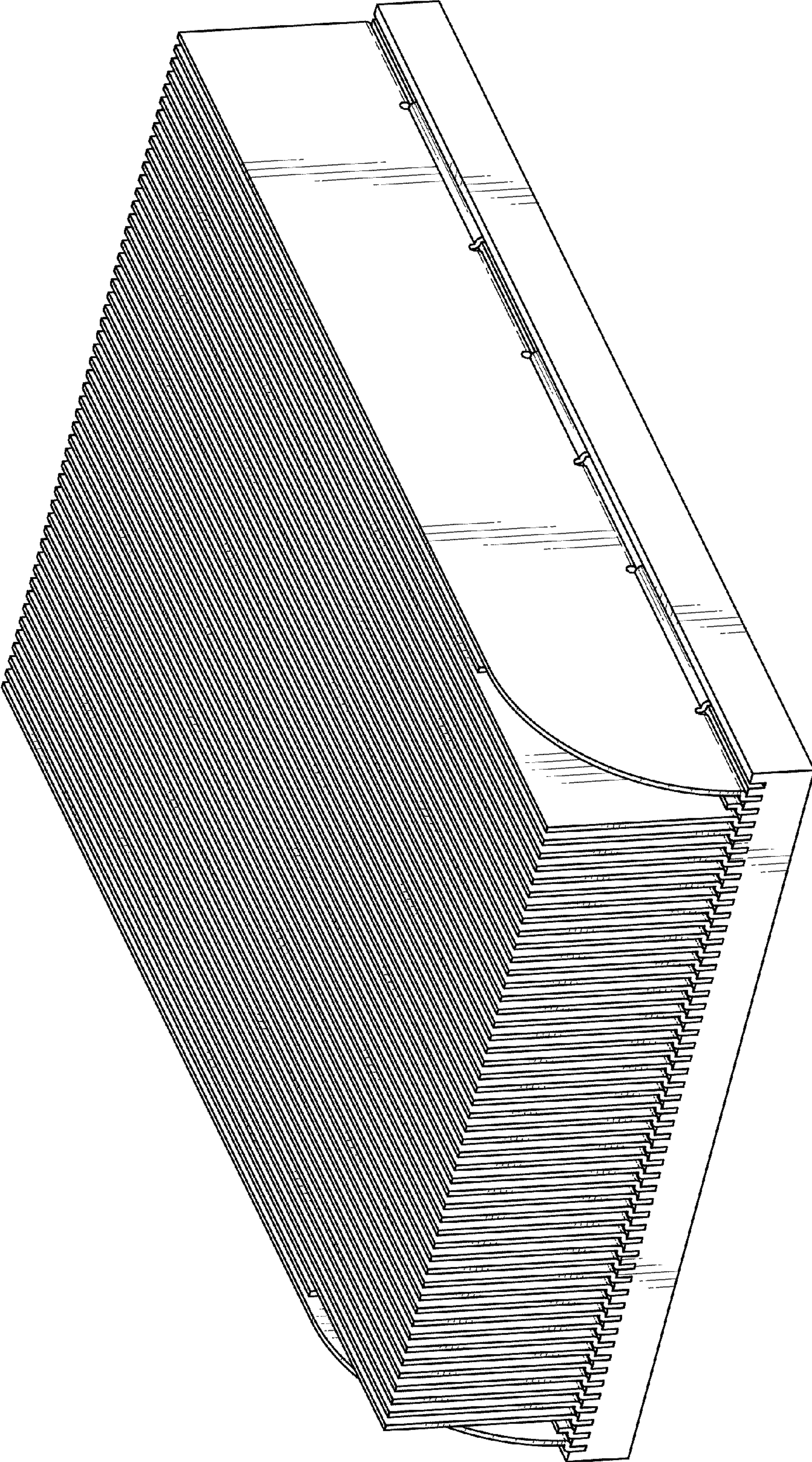


FIG. 8

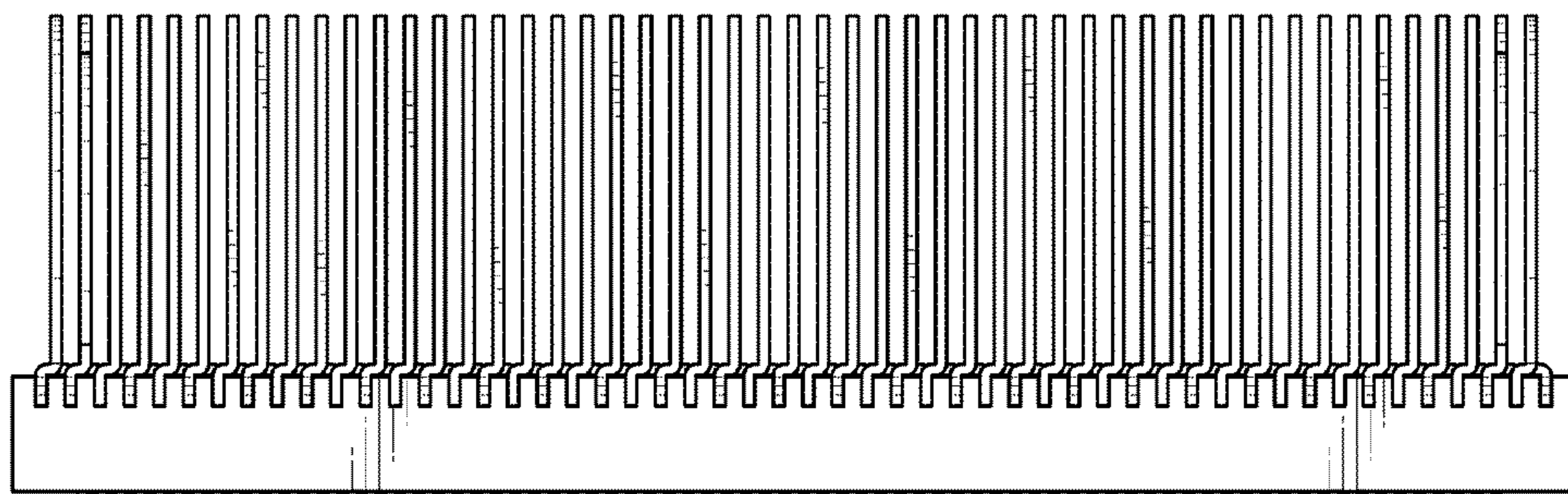


FIG. 9

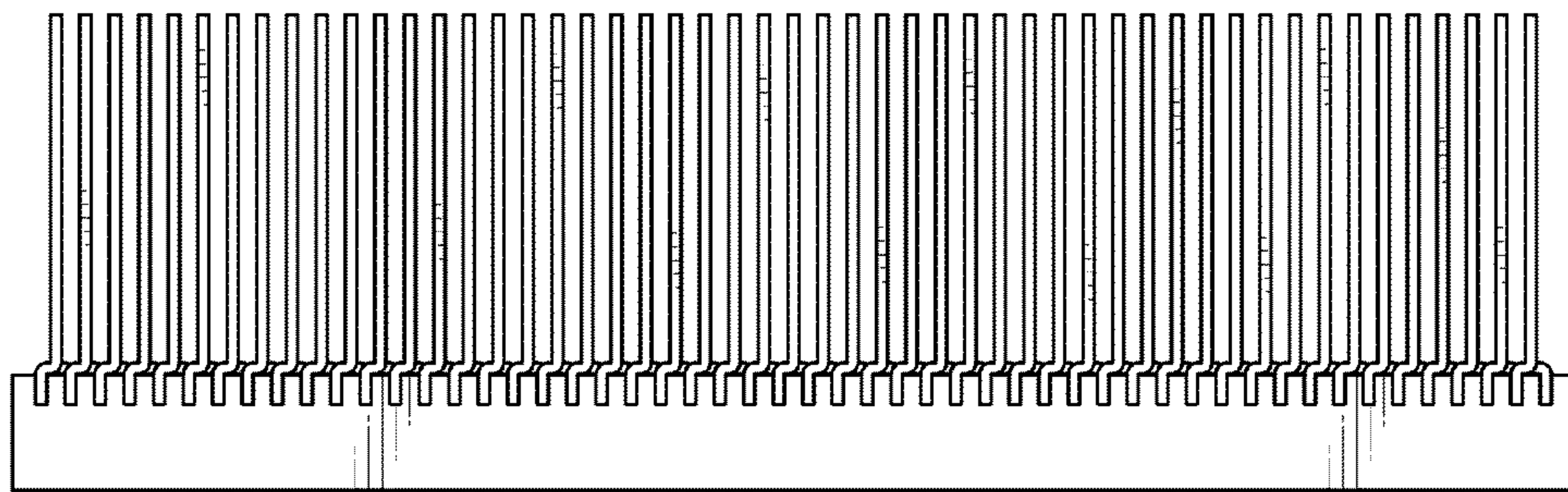


FIG. 10

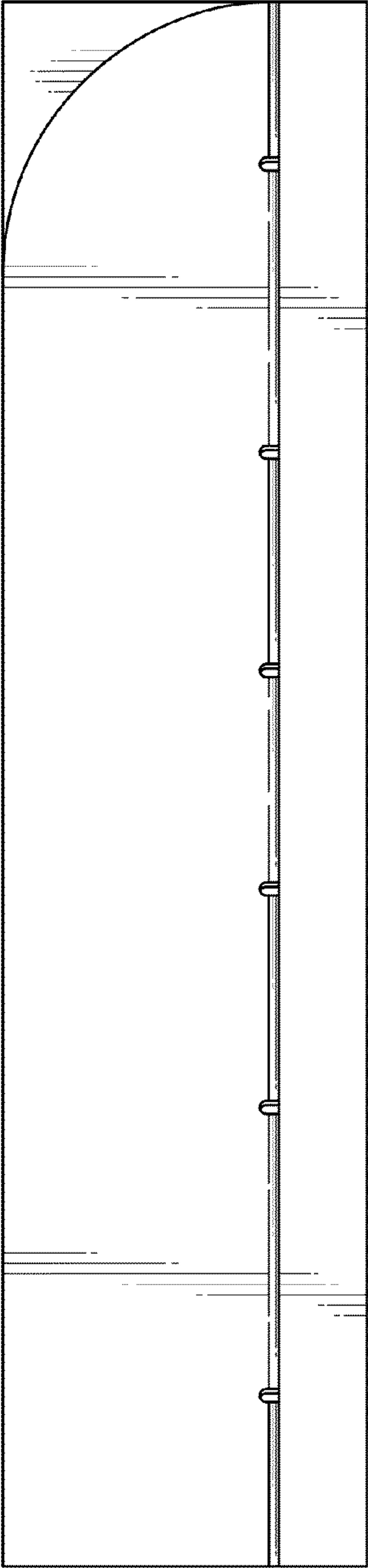


FIG. 11

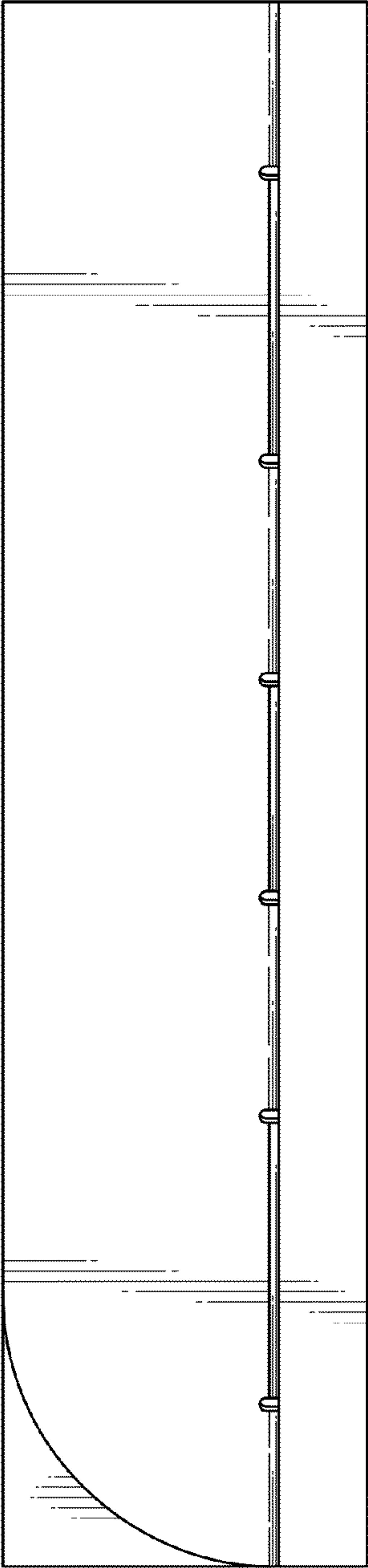


FIG. 12

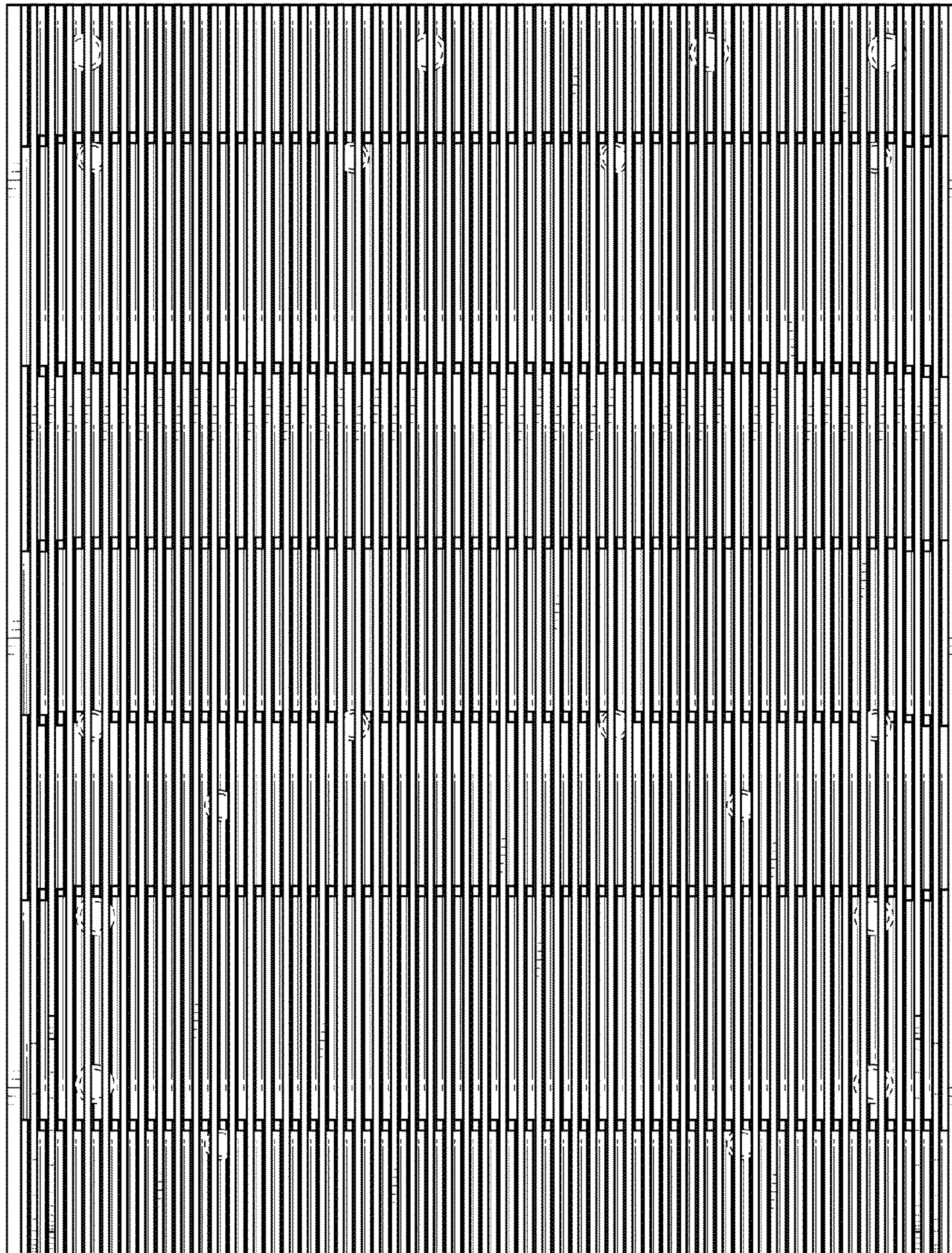


FIG. 13

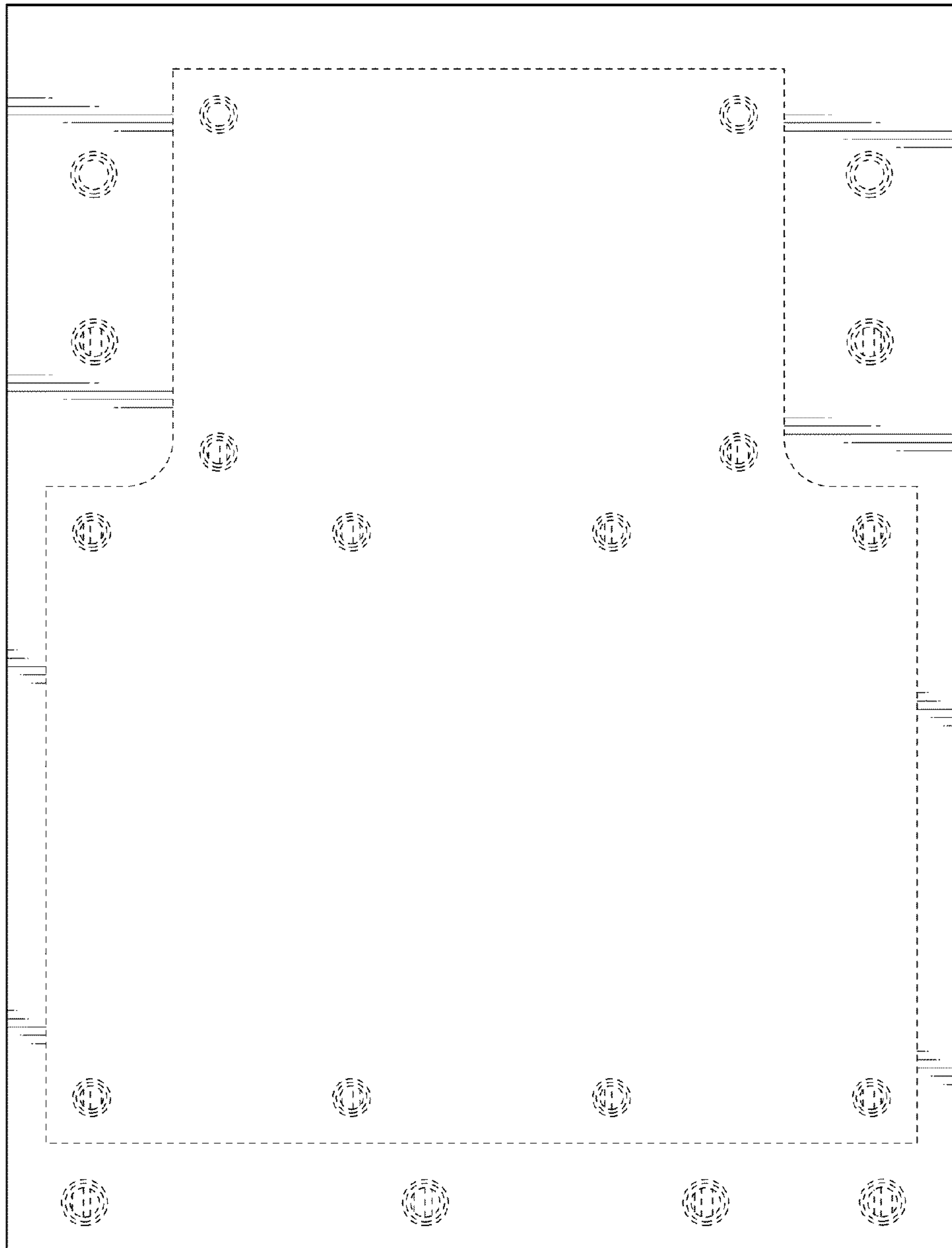


FIG. 14